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Part Number:

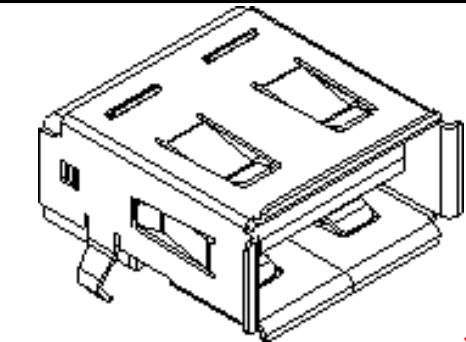
0676430910

Status:

Active

Description:

Universal Serial Bus (USB) Shielded I/O Receptacle, Right Angle, Type A, Black Polyester, Gold (Au) Flash, PCB Thickness 1.60mm (.063"), without Upper Flange, Lead Free



Series
image - Reference only

Documents:

3D Model

Drawing (PDF)

Product Specification PS-67643-003 (PDF)

RoHS Certificate of Compliance (PDF)

General

Product Family

Series

Application

Comments

Component Type

Product Name

Type

I/O Connectors

67643

Wire-to-Board

Without Upper Flange|Not for IR Reflow Process

Receptacle

USB

A

Physical

Boot Color

Circuits (Loaded)

Circuits (maximum)

Gender

Keying to Mating Part

Lock to Mating Part

Material - Plating Mating

Material - Plating Termination

Number of Rows

Orientation

PC Tail Length (in)

PC Tail Length (mm)

PCB Locator

PCB Retention

PCB Thickness Recommended (in)

PCB Thickness Recommended (mm)

Packaging Type

Panel Mount

Pitch - Mating Interface (in)

Pitch - Mating Interface (mm)

Pitch - Term. Interface (in)

Pitch - Term. Interface (mm)

Polarized to Mating Part

Polarized to PCB

Ports

Surface Mount Compatible (SMC)

Temperature Range - Operating

Termination Interface: Style

Waterproof / Dustproof

N/A

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Receptacle

Yes

Yes

Gold

Tin

1

Right Angle

0.102 In

2.60 mm

Yes

Yes

0.062 In

1.60 mm

Tray

Yes

0.079 In, 0.098 In

2.00 mm, 2.50 mm

0.079 In, 0.098 In

2.00 mm, 2.50 mm

Yes

Yes

1

No

-40°C to +85°C

Through Hole

No

Electrical

Current - Maximum per Contact

Shield Type

Shielded

Voltage - Maximum

1.5A

Full Shield

Yes

30V DC

EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Not Reviewed

Halogen-Free

Status

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
67643Series

Mates With
USB Type A Plug

Solder Process Data

Lead-free Process Capability	Wave Capable (TH only)
Process Temperature max. C	260

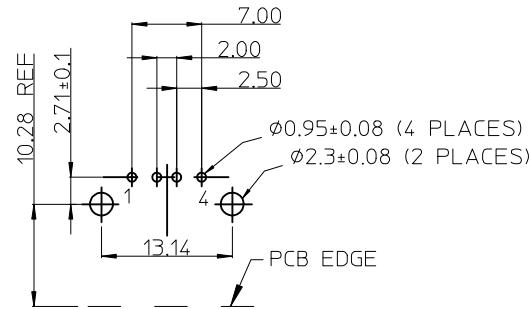
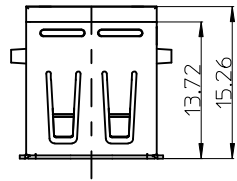
Material Info

Reference - Drawing Numbers

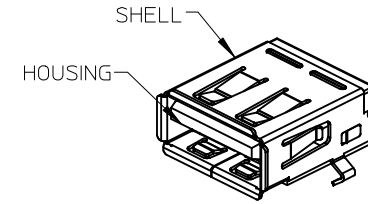
Product Specification	PS-67643-003
Sales Drawing	SD-67643-003

This document was generated on 03/31/2010

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PCB LAYOUT (TOP VIEW)



NOTES:

1. MATERIAL:

- ① METAL SHELL: COPPER ALLOY.
- ② HOUSING: SEE CHART, 30% GLASS FIBER FILLED, UL94-V0.
- ③ TERMINAL: PHOSPHOR BRONZE

2. TERMINAL:

CONTACT AREA: (a) GOLD FLASH.

(b) GOLD (Au), THICKNESS=30 MICROINCH MINIMUM.
SOLDER TAIL: TIN PLATED, THICKNESS=75 MICROINCH MINIMUM.
UNDER PLATED: NICKEL (Ni), THICKNESS=50 MICROINCH MINIMUM.
METAL SHELL: SEE CHART.

3. RECOMMENDED PCB THICKNESS: SEE CHART

4. PRODUCT SPECIFICATION: FOR IR REFER TO PS-67643-002

FOR NON IR REFER TO PS-67643-003

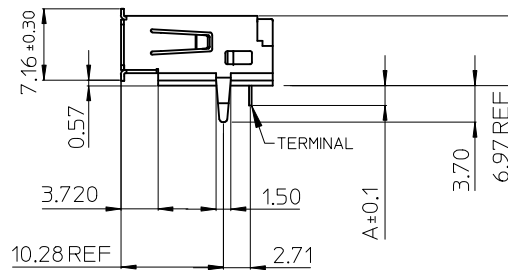
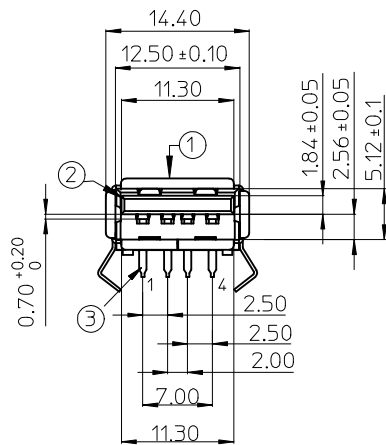
5. TORQUE FORCE SPEC: 2.50kg-cm Min, MEASURED AT BROKEN POINT.

6. TEST SUMMARY: FOR IR REFER TO TS-67643-002

FOR NON IR REFER TO TS-67643-003

7. PACKAGE: REFER TO PK-67643-002

8. LEAD FREE AND ROHS COMPLIANT PRODUCT



REVISED	EC NO:	2009/08/28	DRWN: YPWU	CHKD:	APPR:	DESCRIPTION	REV	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION		
												MM ONLY		1:1	METRIC			
												DRAWN BY	DATE	TITLE				
												IVY-LIN	2005/03/31					
												CHECKED BY	DATE	USB A TYPE RCPT SINGLE RA THROUGH HOLE W/OFLG (LEAD-FREE VERSION)				
												ALL IN	2005/03/31					
												APPROVED BY	DATE	MOLEX INCORPORATED				
												MWSCHANG	2005/03/31					
												MATERIAL NO.		DOCUMENT NO.			SHEET NO.	
												SEE SHEET2		SD-67643-003			1 OF 2	
			SIZE A4		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION													
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS															

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P/N	HOUSING MATERIAL	COLOR	CONTACT PLATING	METAL SHELL PLATING	REMARK
67643-0910	POLYESTER	BLACK	GOLD FLASH	IR REFLOW PROCESS MATTE TIN PLATED AT SOLDER AREA THICKNESS=100 MICROINCH MINIMUM UNDER PLATE:NICKEL (Ni),(SOLDERING AVAILABLE)	NON IR
67643-1910	POLYESTER	WHITE			REFLOW PROCESS
67643-2910	HIGH TEMPERATURE NYLON	BLACK			FOR IR
67643-3910	HIGH TEMPERATURE NYLON	WHITE			REFLOW PROCESS
67643-0911	POLYESTER	BLACK	GOLD PLATING 30 MICROINCH	NON IR REFLOW PROCESS: MATTE TIN PLATED. THICKNESS=80 MICROINCH MINIMUM UNDER PLATE:NICKEL (Ni).	NON IR
67643-1911	POLYESTER	WHITE			REFLOW PROCESS
67643-2911	HIGH TEMPERATURE NYLON	BLACK			FOR IR
67643-3911	HIGH TEMPERATURE NYLON	WHITE			REFLOW PROCESS
PCB THICKNESS		1.60±0.05			
DIMENSION "A"		2.60			

P/N	HOUSING MATERIAL	COLOR	CONTACT PLATING	METAL SHELL PLATING	REMARK
67643-0930	HIGH TEMPERATURE NYLON	BLACK	GOLD FLASH	FOR IR REFLOW PROCESS MATTE TIN PLATED AT SOLDER AREA THICKNESS=100 MICROINCH MINIMUM UNDER PLATE:NICKEL (Ni),(SOLDERING AVAILABLE)	FOR IR REFLOW PROCESS
67643-1930	HIGH TEMPERATURE NYLON	WHITE			
67643-0931	HIGH TEMPERATURE NYLON	BLACK	GOLD PLATING		
67643-1931	HIGH TEMPERATURE NYLON	WHITE	30 MICROINCH		
PCB THICKNESS		1.20±0.05			
DIMENSION "A"		2.00			

REVISED EC NO: DRWN:YPU CHKD: APPR:	2009/08/28	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽C=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
					mm	INCH	DRAWN BY IVY-LIN	DATE 2005/03/31	TITLE USB A TYPE RCPT SINGLE RA THROUGH HOLE W/OFLG (LEAD-FREE VERSION)				
				4 PLACES	± ---	± ---	CHECKED BY	DATE					
				3 PLACES	± ---	± ---	ALL IN	2005/03/31	MOLEX INCORPORATED				
				2 PLACES	± 0.25	± ---	APPROVED BY	DATE					
				1 PLACE	± 0.25	± ---	WWSCHANG	2005/03/31	SD-67643-003				
				ANGULAR ± 3 °			MATERIAL NO.						
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE TABLE		SD-67643-003		2 OF 2		
							SIZE A 4	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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